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CONFIRMATION NO. 5592

SERIAL NUMBER 10/767,697	FILING DATE 01/29/2004 RULE	CLASS 438	GROUP ART UNIT 2822	ATTORNEY DOCKET NO. Komatsu Case 267A
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a CIP of 10/169,778 07/02/2002 ABN yes CK  
 which is a 371 of PCT/JP00/08166 11/20/2000 yes CK

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

JAPAN NO. 2000-1645 01/07/2000 yes CK  
 JAPAN NO. 2000-238047 08/07/2000 yes CK

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 06/17/2004

Foreign Priority claimed	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR	SHEETS	TOTAL	INDEPENDENT
35 USC 119 (a-d) conditions met	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance	COUNTRY	DRAWING	CLAIMS	CLAIMS
Verified and Acknowledged <i>Charles Krock CK</i> Examiner's Signature	Initials	JAPAN	1	7	2

## ADDRESS

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 49008-1631

## TITLE

Metal plating method, pretreatment agent, and semiconductor wafer and semiconductor device obtained using these

<input type="checkbox"/> All Fees
<input type="checkbox"/> 1.16 Fees ( Filing )